505602855 08/02/2019

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5649655

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
MARKUS WIMPLINGER	07/25/2017

# **RECEIVING PARTY DATA**

Name:	EV GROUP E. THALLNER GMBH
Street Address:	DI ERICH THALLNER STRASSE 1
City:	ST. FLORIAN AM INN
State/Country:	AUSTRIA
Postal Code:	A-4782

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16483077

### **CORRESPONDENCE DATA**

Fax Number: (440)684-1095

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 440-684-1090

Email: Icahill@kusnerjaffe.com

**Correspondent Name:** MICHAEL A. JAFFE, KUSNER & JAFFE Address Line 1: 6150 PARKLAND BOULEVARD, SUITE 105

Address Line 2: PARAGON CENTER II

Address Line 4: MAYFIELD HEIGHTS, OHIO 44124

ATTORNEY DOCKET NUMBER:	BE11749WO(US)
NAME OF SUBMITTER:	MICHAEL A. JAFFE
SIGNATURE:	/Michael A. Jaffe/
DATE SIGNED:	08/02/2019

**Total Attachments: 2** 

source=BE11749WOUS-Assignment#page1.tif source=BE11749WOUS-Assignment#page2.tif

> **PATENT** REEL: 049939 FRAME: 0226 505602855

Practitioner's Docket No. BE11749WO(US) Applicant Ref: EVG 102793-WO-US

For: U.S. Rights
For: U.S. Application

By: Inventors

#### ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR(S) of the sum of Ten Dollars (\$10.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

#### ASSIGNOR(S):

Name: Markus Wimplinger

Address: Richard-Billinger-Weg 18/1

A-4910, Ried in Kreis

**AUSTRIA** 

hereby sells, assigns and transfers to

ASSIGNEE:

Name: EV Group E. Thallner GmbH Address: DI Erich Thallner Strasse 1

A-4782, St. Florian am Inn

**AUSTRIA** 

Country of Formation: AUSTRIA

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to any and all improvements which are disclosed in the invention entitled:

#### METHOD AND DEVICE FOR BONDING OF CHIPS

and which is found in (37 C.F.R.	§3.21) U.S. patent application	executed on even	date	herewith	or [ ]	in
Application No.	, filed on		and,	in and	to, a	3[[
Letters Patent to be obtained for				tinuation,	divisio	n,
renewal, or substitute thereof, and	as to letters patent any reissue of	r re-examination t	hereo	£.		

ASSIGNOR(S) hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR(S) further covenant(s) that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR(S) and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

Assignment of Invention-page 1 of 2

PATENT REEL: 049939 FRAME: 0227 ASSIGNOR(S) hereby grant(s) the firm of Kusner & Jaffe the power to insert or complete on this assignment document any information, including application number and filing date, which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

I/We have hereunto set my/our hand(s) on the date(s) set forth below.

Date: July 25th 2017

Signature of Markus Wimplinger

Assignment of Invention-page 2 of 2